

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Akihiko ENDO et al.

Group Art Unit: 2812

Appln. No. : 10/570,663

Examiner: Hsien M. LEE
(U.S. National Stage entry of PCT/JP2004/013069)

I.A. Filed : September 8, 2004

For : METHOD FOR PRODUCING BONDED WAFER

RESPONSE TO RESTRICTION REQUIREMENT WITH TRAVERSE

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop AMENDMENT
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

This is in response to the requirement for restriction under 35 U.S.C. § 121 mailed from the U.S. Patent and Trademark Office on June 27, 2007, which sets forth a one-month shortened statutory period for response, to end July 27, 2007.

Applicants note that this response is being filed prior to expiration of the one-month shortened statutory period, whereby an extension of time and the government fee associated therewith should not be necessary for maintaining the pendency of the application. However, if any extension of time and/or fee is necessary for maintaining the pendency of the application, Applicants expressly request any necessary extension of time and authorize the charging of any required fee to Deposit Account No. 19-0089.

Reconsideration and withdrawal of the requirement for restriction are respectfully requested in view of the remarks which follow: